



2025年第三季法說會

Nov. 5th, 2025

winbond
We Deliver

- We have made forward-looking statements in this presentation. Our forward-looking statements contain information regarding, among other things, our financial condition, future expansion plans and business strategies. We have based these forward-looking statements on our current expectations and projections about future events. Although we believe that these expectations and projections are reasonable, such forward-looking statements are inherently subject to risks, uncertainties and assumptions about us.
- We undertake no obligation to publicly update or revise any forward-looking statements whether as a result of new information, future events or otherwise. In light of these risks, uncertainties and assumptions, the forward-looking events discussed in this conference might not occur and our actual results could differ materially from those anticipated in these forward-looking statements.
- The information contained herein shall also not constitute an offer to sell or a solicitation of an offer to buy the company's securities nor shall there be any sale of such securities in any state or country in which such offer, solicitation or sale would be unlawful prior to registration or qualification under the securities laws of any such state or country.

01 財務報告

范祥雲 執行副總經理

02 營運回顧及展望

陳沛銘 總經理

03 重要營運成果

林正恭 METC 董事長

04 Q & A

財務報告

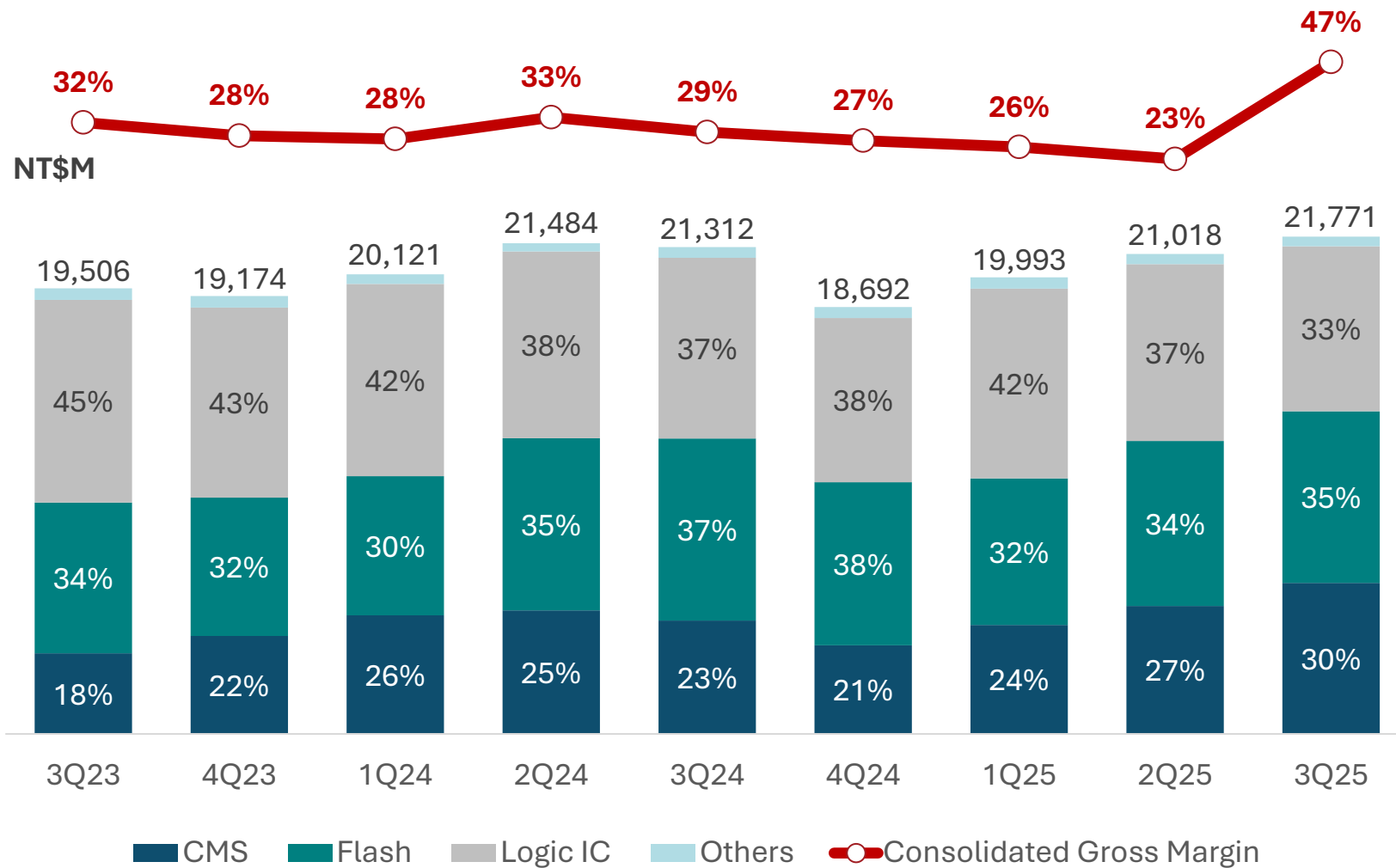
綜合損益表 – 合併

(除另予註明者外，金額為新台幣佰萬元)

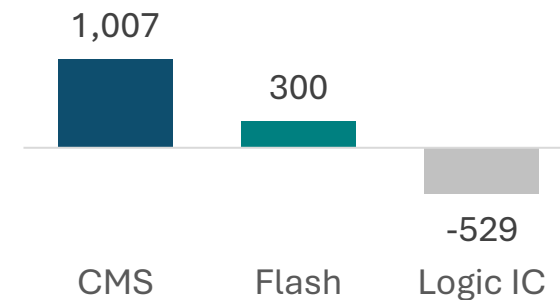
	3Q25	2Q25	QoQ	3Q24	YoY
營業收入	21,771	21,018	+3.6%	21,312	+2.1%
營業毛利	10,166	4,763	+113.4%	6,246	+62.7%
營業毛利率	46.7%	22.7%	+24 pts	29.3%	+17 pts
營業費用	6,463	6,058	+6.7%	5,974	+8.2%
營業淨(損)利	3,703	(1,295)	+4,998	272	+3,431
營業淨利率	17.0%	-6.2%	+23 pts	1.3%	+16 pts
營業外收入及支出	(145)	(524)	+379	(297)	+152
所得稅費用(利益)	857	(188)	+1,045	35	+822
本期淨(損)利	2,701	(1,631)	+4,332	(60)	+2,761
純益率	12.4%	-7.8%	+20 pts	-0.3%	+13 pts
歸屬予母公司業主之本期淨(損)利	2,943	(1,312)	+4,255	(9)	+2,952
每股盈餘 (新台幣元)	<u>NT\$0.65</u>	<u>NT\$-0.29</u>		-	
2025年前三季累計每股盈餘 (新台幣元)	<u>NT\$0.12</u>				
稅前息前折舊攤銷前利益	7,048	1,741		3,532	
平均匯率--USD/NTD	29.78	31.03		32.33	

產品別營業收入 - 合併

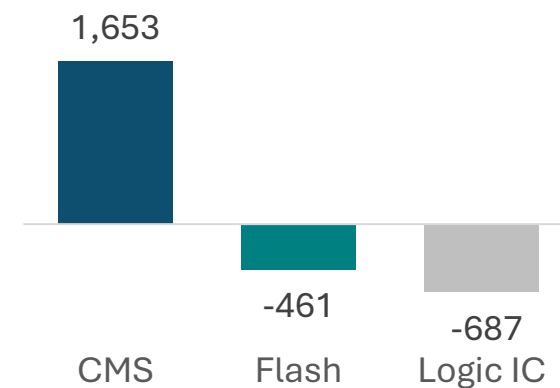
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3Q25 vs. 2Q25 (QoQ)



3Q25 vs. 3Q24 (YoY)



*CMS代表客製化記憶體事業，更名自過往之DRAM事業

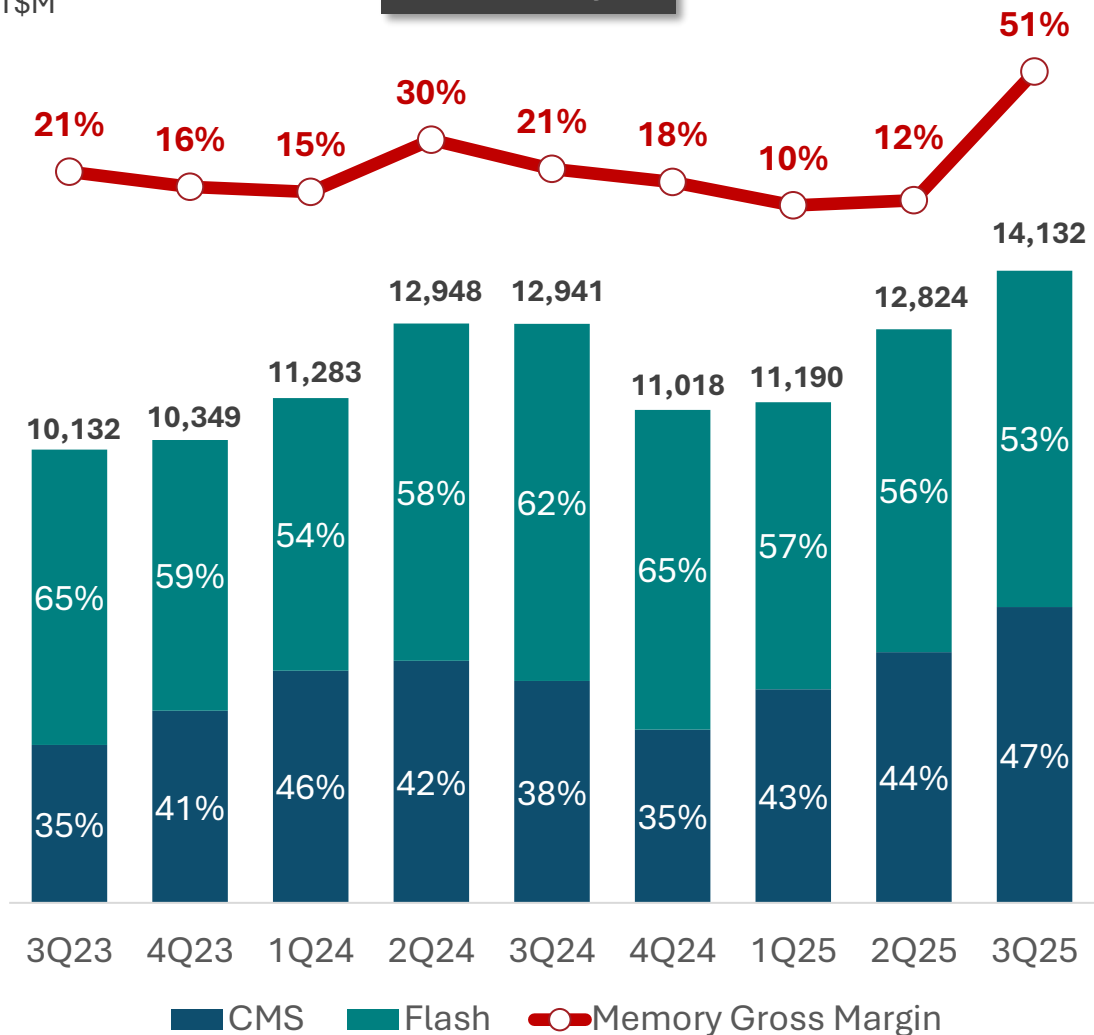
**其他收入為軟體服務收入，主要來自AMTC及METC兩家子公司，約佔合併營收1至3%

產品別營業收入及毛利率－合併

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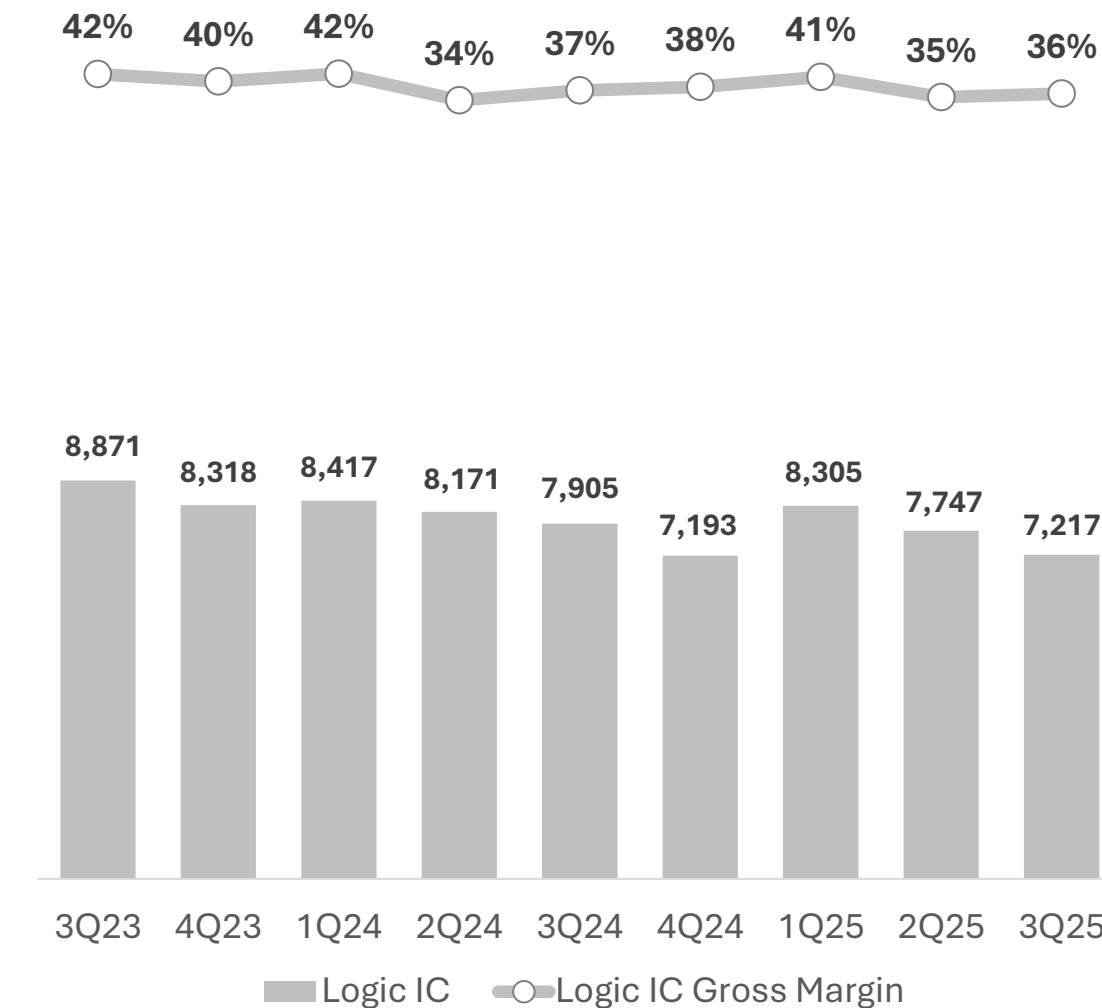
Memory

NT\$M



Logic IC

NT\$M



(除另予註明者外，金額為新台幣佰萬元)

	3Q25	2Q25	QoQ	3Q24	YoY
營業收入	14,132	12,824	+10.2%	12,941	+9.2%
營業毛利	7,183	1,547	+364.2%	2,777	+158.7%
營業毛利率	50.8%	12.1%	+39 pts	21.5%	+29 pts
營業費用	2,988	2,644	+13.0%	2,573	+16.1%
營業淨(損)利	4,195	(1,097)	+5,291	204	+3,991
營業淨利率	29.7%	-8.6%	+38 pts	1.6%	+28 pts
產能利用率	~100%	~90%		90~100%	

資產負債表 – 合併

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(除另予註明者外，金額為新台幣佰萬元)

	09.30.2025		06.30.2025		09.30.2024	
現金及約當現金	17,203	9%	20,317	11%	15,505	8%
應收帳款	13,302	7%	11,855	7%	11,563	6%
存貨	25,251	14%	21,629	12%	23,057	13%
長期投資	22,853	12%	18,400	10%	24,379	13%
不動產、廠房、設備及使用權資產	97,815	54%	99,734	56%	104,445	56%
資產總計	182,603	100%	179,573	100%	186,256	100%
流動負債	51,034	28%	42,031	23%	42,394	23%
長期計息負債	20,246	11%	33,266	18%	31,430	17%
負債總計	81,215	44%	85,269	47%	80,968	43%
股東權益總計	101,388	56%	94,304	53%	105,288	57%
每股淨值 (新台幣元)	21.08		19.48		21.68	
負債/權益比	0.80		0.90		0.77	
流動比率	1.33		1.55		1.53	

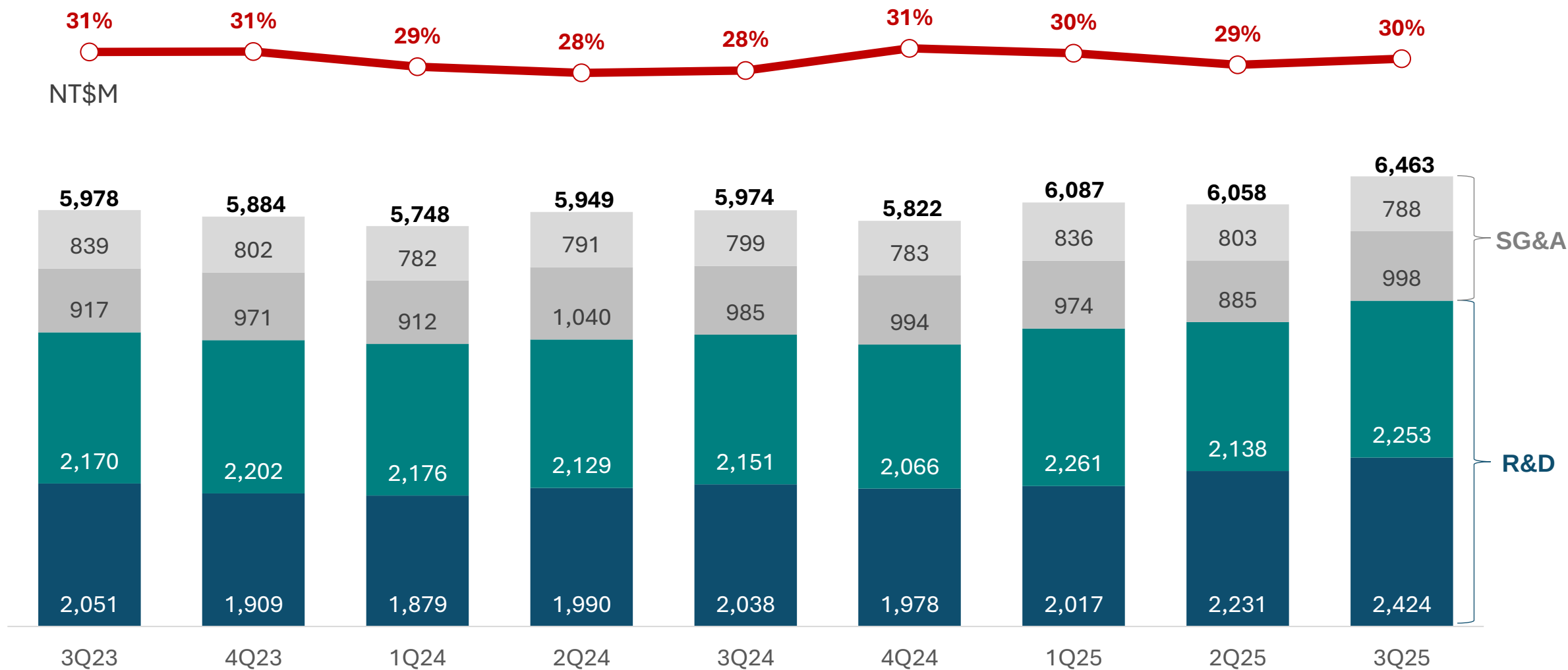
* 2025年09月30日流通在外股數為45億股

(除另予註明者外，金額為新台幣佰萬元)	3Q25	2Q25	3Q24
營運活動之現金流量	2,836	2,437	2,096
折舊與攤銷費用	3,126	3,210	3,236
投資活動之現金流量	(1,621)	(1,824)	(2,982)
資本支出	(1,368)	(1,412)	(2,913)
籌資活動之現金流量	(4,596)	2,442	2,696
銀行借款	5,559	2,698	(3,009)
普通公司債	(10,000)	-	-
現金增資	-	-	6,703
本期現金及約當現金淨增加(減少)數	(3,114)	1,939	2,096
期末現金及約當現金餘額	17,203	20,317	15,505
自由現金流量*	1,468	1,025	(817)

*自由現金流量 = 營運活動之現金流量 – 資本支出

營業費用 - 合併

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■ 研發費用-Memory* ■ 研發費用-Logic IC ■ 管銷費用-Memory* ■ 管銷費用-Logic IC ● 營業費用佔營收比率

*包含記憶體及軟體服務事業之營業費用

邏輯事業 – 新唐之綜合損益表

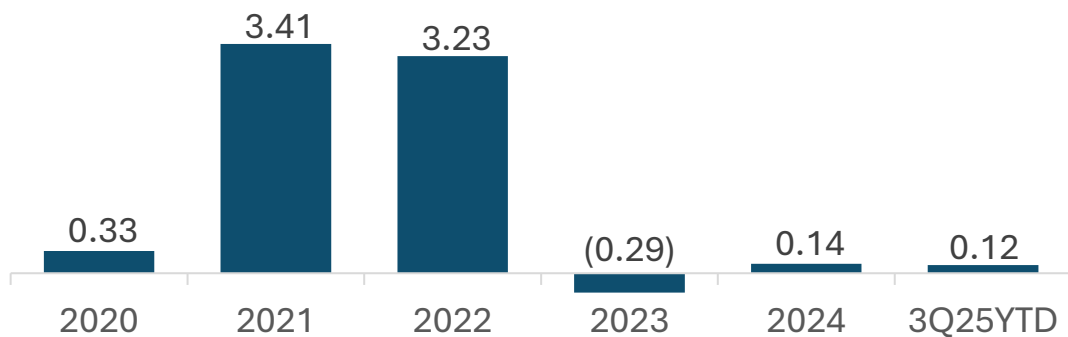
(除另予註明者外，金額為新台幣佰萬元)	3Q25	2Q25	QoQ	3Q24	YoY
營業收入	7,272	7,816	-7.0%	7,957	-8.6%
營業毛利	2,597	2,728	-4.8%	2,972	-12.6%
營業毛利率	35.7%	34.9%	+1 pts	37.3%	-2 pts
營業費用	3,113	3,030	+2.8%	3,004	+3.6%
營業淨利率	-7.1%	-3.9%	-3 pts	-0.4%	-7 pts
營業外收入及支出	45	(343)	+388	(4)	+49
所得稅費用(利益)	(43)	(30)	-12	(70)	+27
本期淨(損)利	(513)	(675)	+161	(105)	-408
純益率	-7.1%	-8.6%	+2 pts	-1.3%	-6 pts
每股盈餘 (新台幣元)	<u>-NT\$1.22</u>	<u>-NT\$1.61</u>		<u>-NT\$0.25</u>	

(除另予註明者外，金額為新台幣佰萬元)

	09.30.2025		06.30.2025		09.30.2024	
現金及約當現金	9,584	29%	9,685	29%	5,272	17%
應收帳款	4,239	13%	4,353	13%	4,013	13%
存貨	6,188	19%	6,537	19%	6,759	22%
長期投資	2,723	8%	2,636	7%	3,441	11%
不動產、廠房、設備及使用權資產	7,702	23%	7,766	24%	8,496	28%
資產總計	32,799	100%	33,563	100%	30,716	100%
流動負債	10,972	33%	11,037	33%	9,102	30%
非流動負債	8,010	24%	8,462	25%	5,512	18%
負債總計	18,982	58%	19,499	58%	14,614	48%
股東權益總計	13,817	42%	14,064	42%	16,102	52%
每股淨值 (新台幣元)	32.91		33.50		38.36	
負債/權益比	1.37		1.39		0.91	
流動比率	1.92		1.98		1.87	

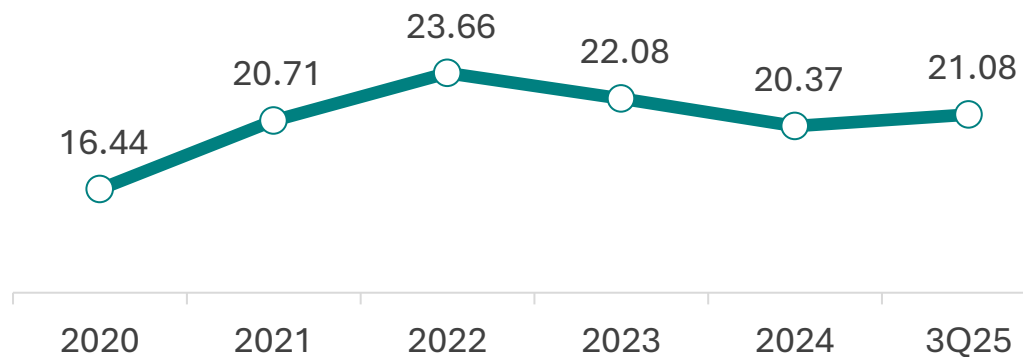
每股盈餘

新台幣元



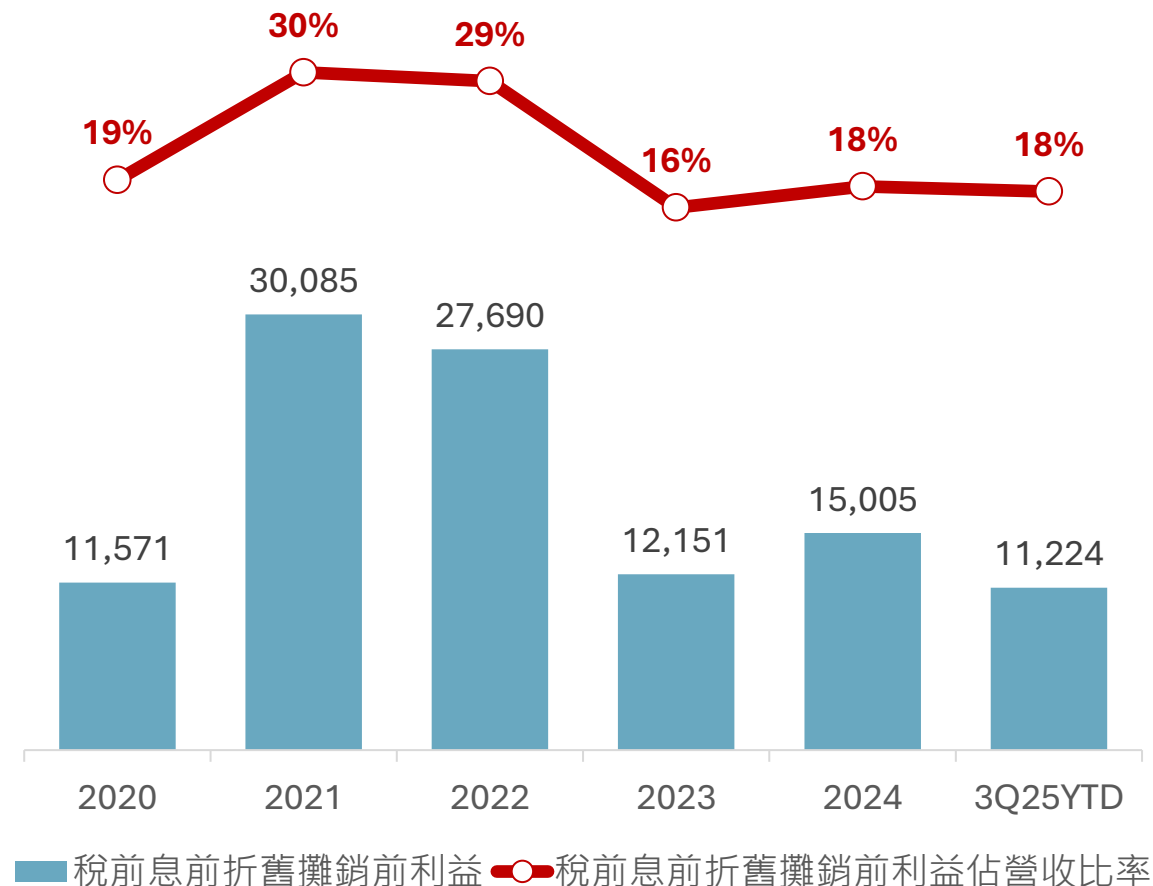
每股淨值

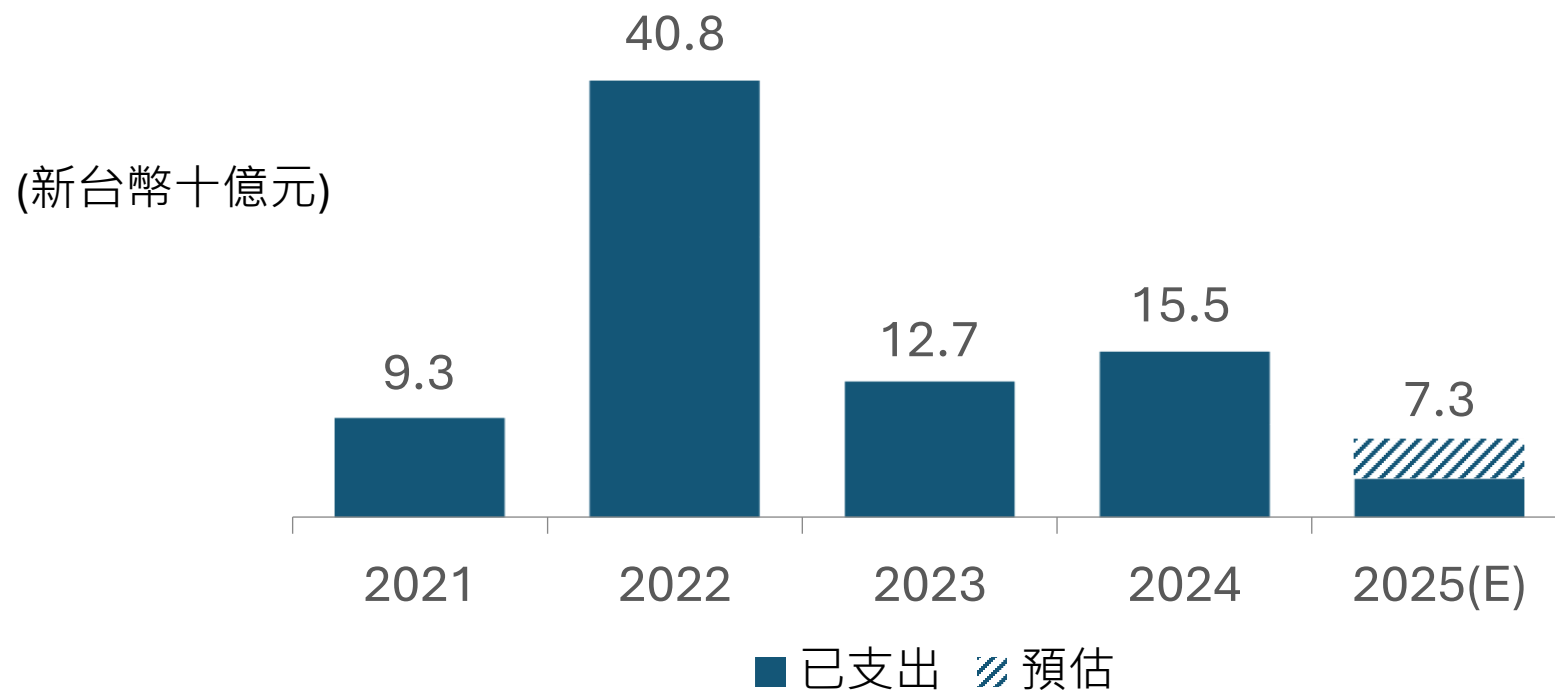
新台幣元



稅前息前折舊攤銷前利益

新台幣佰萬元





現金基礎資本支出截至2025年11月5日

- 2025年前三季累計資本支出為新台幣36億元
- 2025年資本支出計畫約為新台幣73億元，其中生產設備資本支出約佔8成

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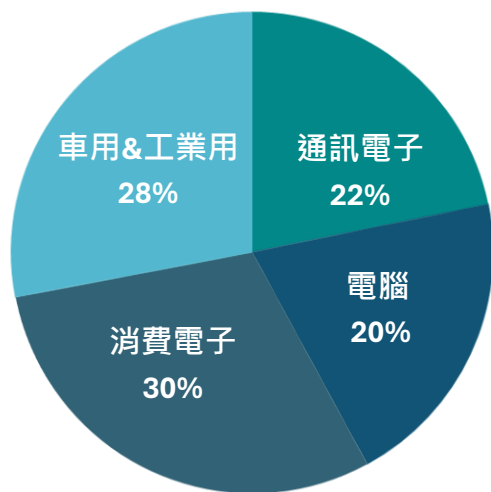
營運回顧及展望

	QoQ 3Q25 vs. 2Q25	YoY 3Q25 vs. 3Q24
	CMS	CMS
營業收入	+18.0%	+33.3%
位元出貨量	季增中個位數百分比	年增低六十位數百分比
混合平均售價(US\$)	季增中十位數百分比	年減低十位數百分比
	Flash	Flash
營業收入	+4.2%	-5.8%
位元出貨量	季增低個位數百分比	年增高十位數百分比
混合平均售價(US\$)	季增中個位數百分比	年減低十位數百分比
匯率	-4.0%	-7.9%

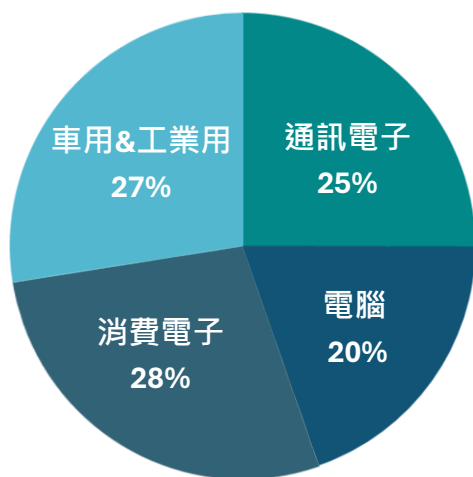
記憶體營收 – 應用面 (QoQ)

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3Q25

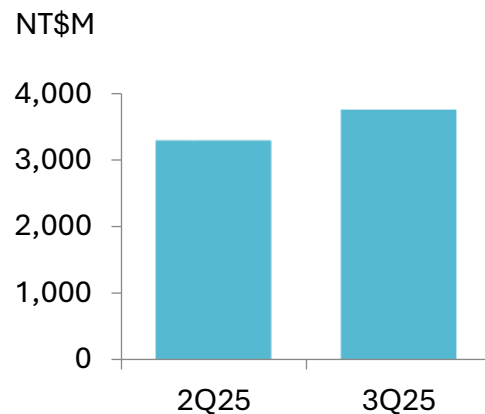


2Q25



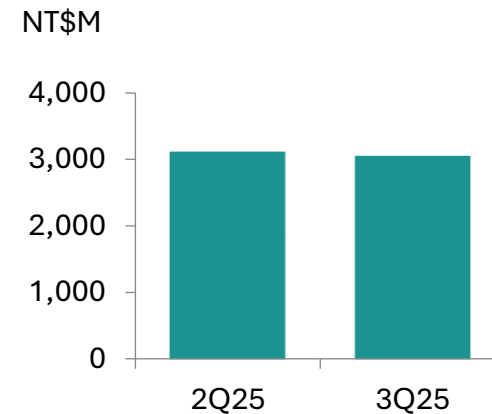
車用 & 工業用

QoQ +14%



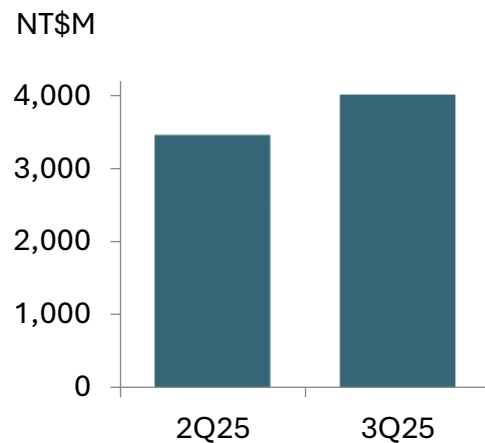
通訊電子

QoQ -2%



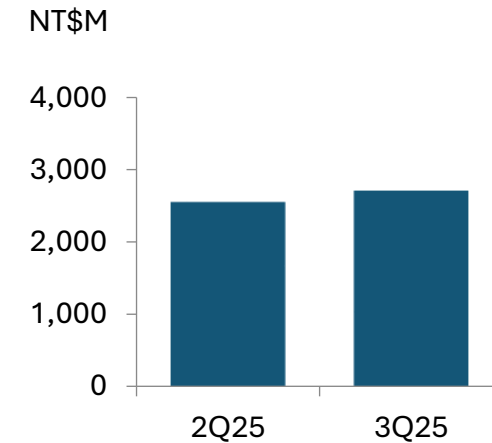
消費電子

QoQ +16%

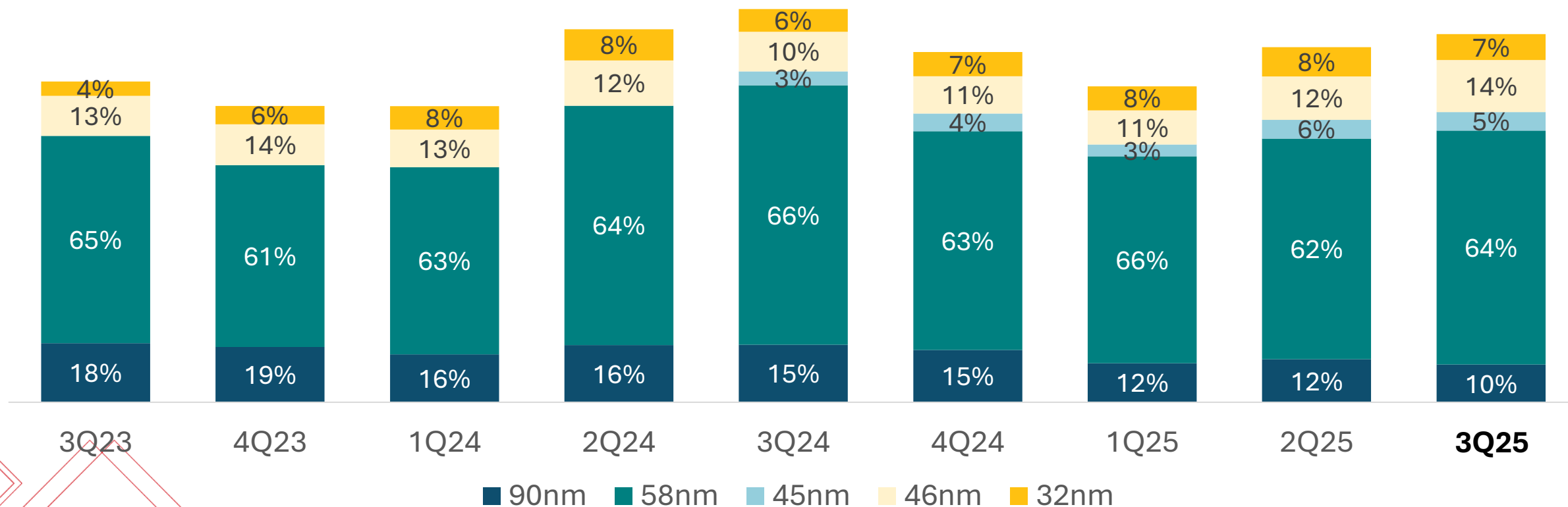


電腦

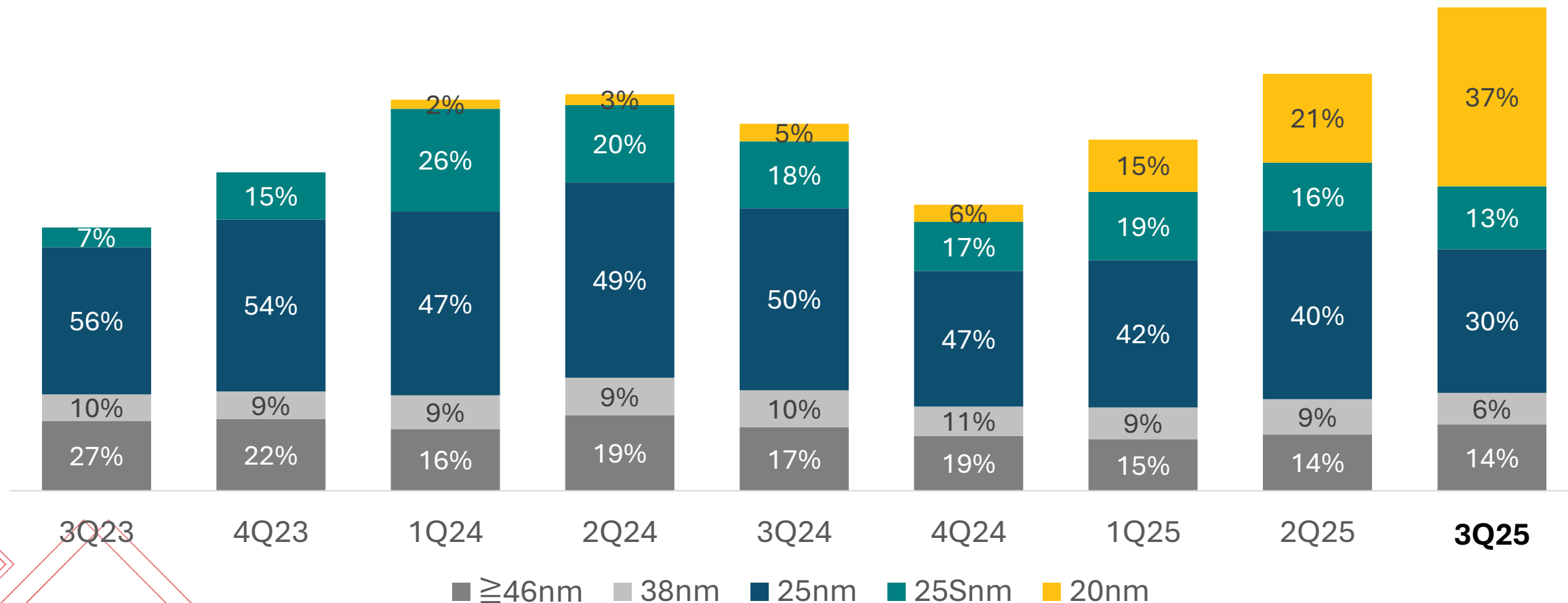
QoQ +6%



- ❑ 2025年第三季營收季增4%，年減6%
- ❑ NOR Flash營收穩定成長，高容量產品有利組合優勢漸顯
- ❑ 2025年第三季SLC NAND產品線位元出貨量年增中二十位數百分比
- ❑ 穩居世界第一NOR Flash供應商



- 2025年第三季營收季增18%，年增33%，為近三年新高
- 2025年第三季位元出貨量年增低六十位數百分比
- 2025年第三季20nm營收躍升，主要受惠於DDR4銷售季增翻倍



❑ Code Storage Flash

- ❖ 基於原物料成本上升及終端需求回溫，NOR價格預期自2025年第3季起將持續上漲
- ❖ 預期SLC NAND的供給在接下來幾個季度仍將維持吃緊，推升價格進一步上漲
- ❖ 需求成長：車用、筆電、伺服器、TWS

❑ Customized Memory Solution

- ❖ 結構性供應缺口正推動DDR4與DDR3合約價持續上漲，漲勢預期延續至2026年
- ❖ 伴隨主要大廠逐步退出DDR4供給，現有產能不足以滿足市場長期需求；供需失衡狀態使現有供應商受益
- ❖ 需求成長：智慧家庭、無人機、M2M、網通；需求健康：電視

□ 整體市場

- ❖ 全球經濟逐步復甦，並帶來新的商機
- ❖ 美中角力持續；需聚焦於供應鏈重組與策略規劃
- ❖ AI 熱潮正持續推動記憶體上行循環

□ 華邦營運

- ❖ 2025 年第 3 季轉虧為盈，展現持續強勁的營運動能
- ❖ CMS 16nm製程已完成試產前準備，8Gb DDR4/LPDDR4 產品線預期2026年量產
- ❖ Flash 與 CMS 擴產計畫正進行中，2026 ~ 2027 年資本支出將近新台幣 400 億元
- ❖ CUBE 專案進展順利，預期於 2027 年有顯著貢獻

重要營運成果

-軟體



Winbond Electronics Corporation

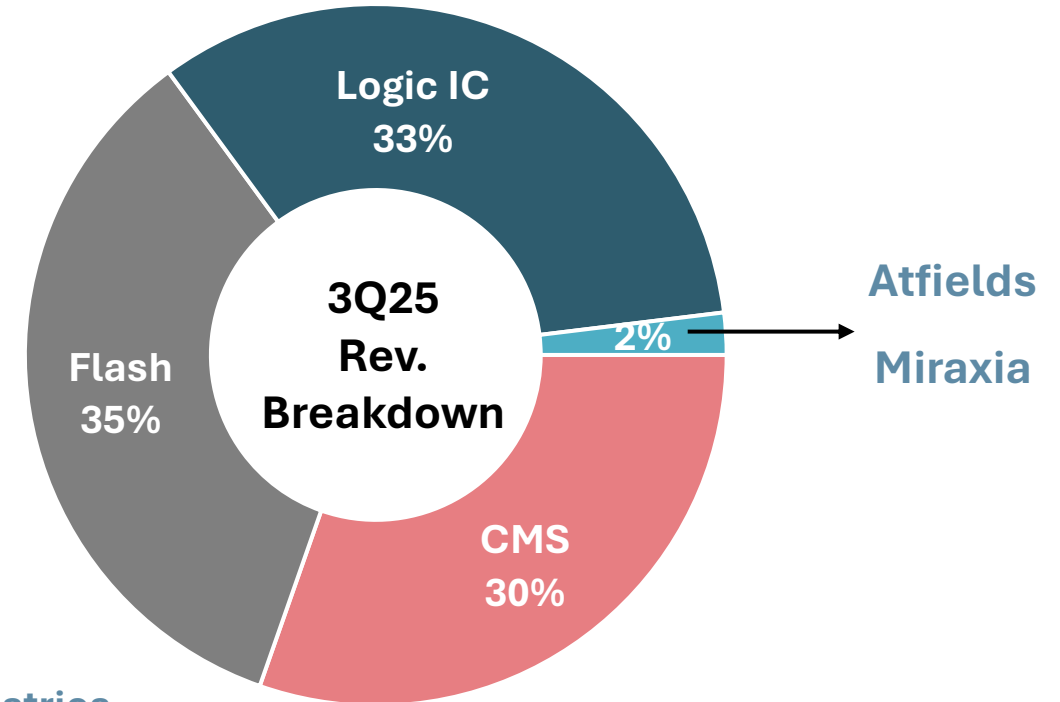
100% owned by Winbond Electronics Corporation

**Atfields Manufacturing Technology Corporation
(AMTC)**

100% owned by Winbond Electronics Corporation

**Miraxia Edge Technology Corporation
(METC)**

- ✓ 100% owned subsidiaries of Winbond, contributing 2-3% of consolidated revenue
- ✓ Complementarity Between Semiconductor and Software Industries
– Capital-Intensive vs. Asset-Light Models



Activity	Providing on-site manufacturing solutions and developing and improving manufacturing methods
Customer	TPSCo, NTCJ, Panasonic, Toyota, and others
Establishment	March 1st, 2000
Chairman	Yoshitaka Kinoshita
President	Mao-Hsiang Yen
Capital	200 million yen

As of Aug 30 2025



Head office

Uozu city/Toyama

800 Higashiyama, Uozu, Toyama 937-8585

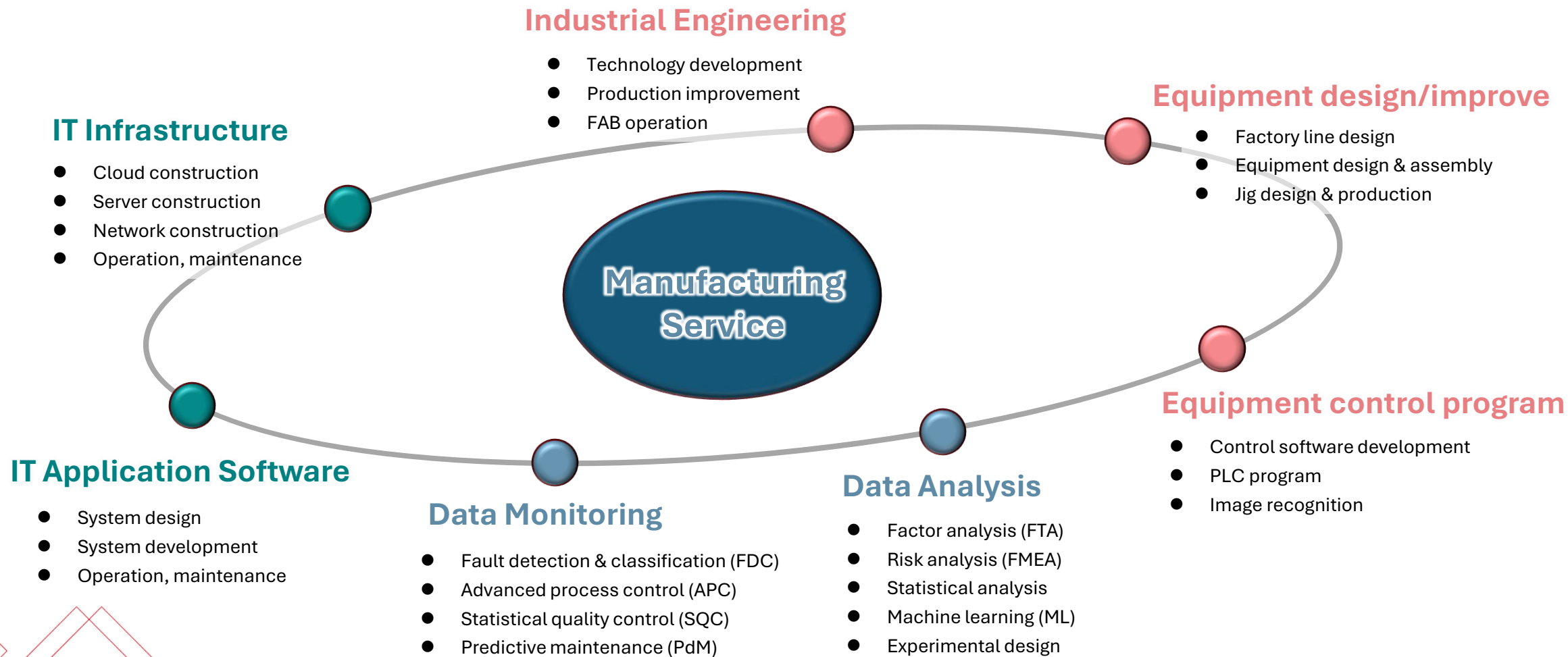


Branch office

- Tonami city, Toyama
- Myoko city, Niigata
- Nagaokakyo city, Kyoto
- Toyota city, Aichi



- Long-term experience in IT/DS/PE/EE in semiconductor factories, provides digital services to improve factory operation efficiency



- Create customer value through improvements in productivity, quality, cost, and delivery
- Also support monitoring and control of manufacturing process and equipment

Digital Transformation Solution service (IT+DS)



Conceptual design for IT



Application development and operation



Development of solution applications



IT infrastructure construction & operation



System monitoring



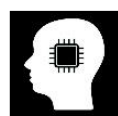
Data collection



Big data analysis



Effective use of data (APC, FDC, etc.)



Custom development of analysis software



Factory data scientist training

Mfg. Tech. service (IE)



Technology development



Production improvement

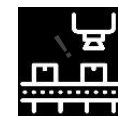
Equip. Tech. service (PE)



Equipment and jigs design/production

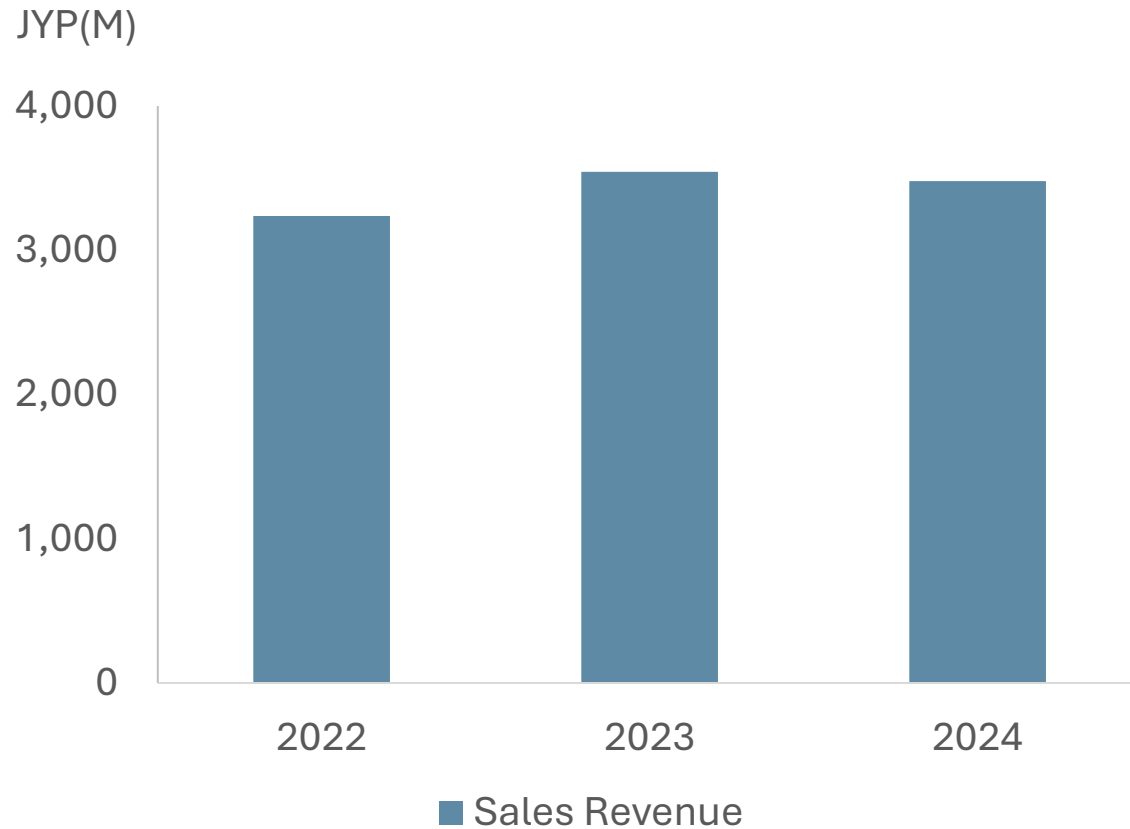


Automatic visual inspection equipment

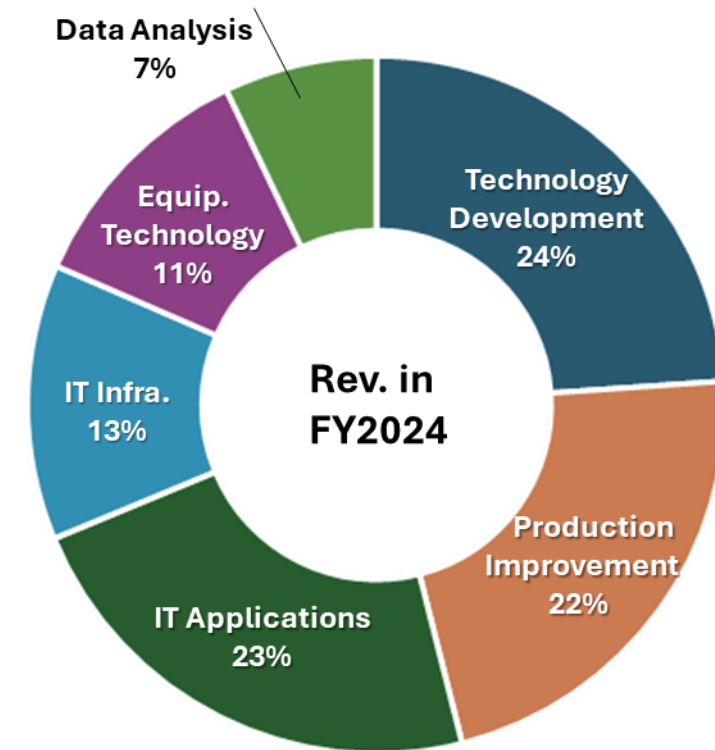


Equipment control program and diagnosis

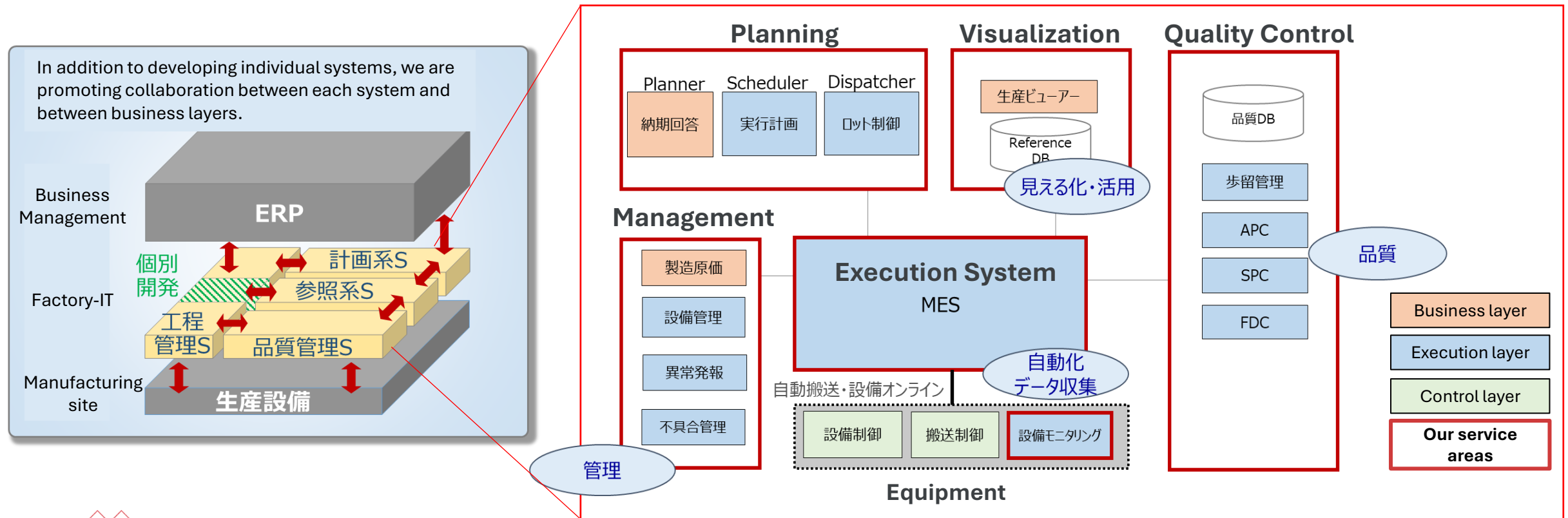
- An engineering company driving manufacturing innovation through semiconductor technologies
- Atfields works with a wide range of companies, primarily in automotive & electronics industries



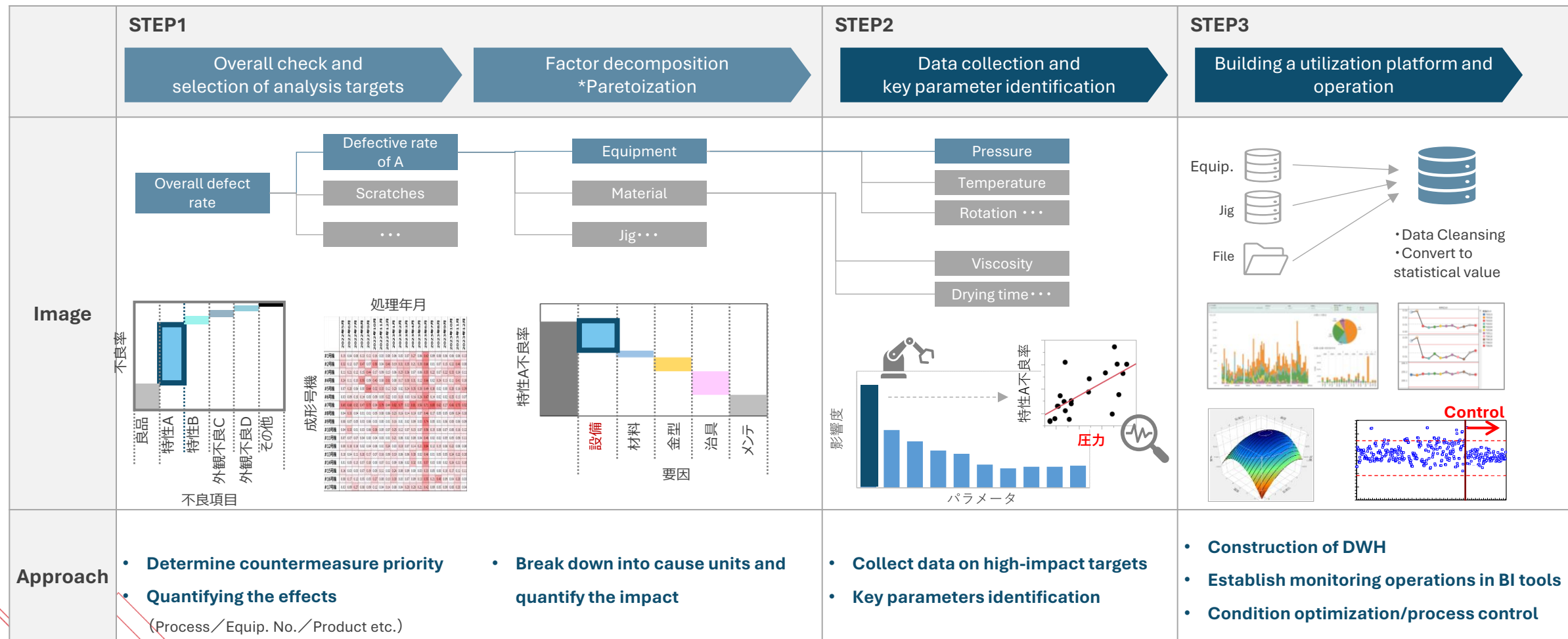
Sales by Service



- Provides comprehensive MES (Manufacturing Execution System) to factories, ranging from full-scale development to partial upgrade
- Optimize and enhance manufacturing systems and environment



- Provides data analysis and monitoring services, using proprietary methods based on expertise in semiconductor mass production

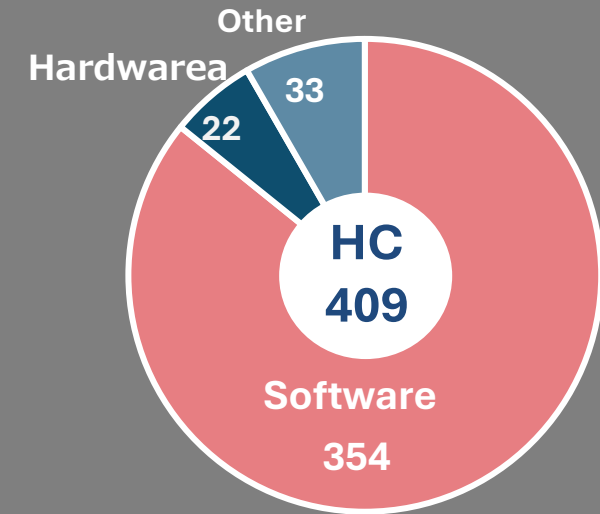


- Atfields supports a broad range of business areas for both domestic and international clients

**Number of factories that Atfields has been working for (excluding group companies), as of August 2025*

Customer's domain	Number of factories (overseas)	IT service	DS service	IE service	PE service
Semiconductor	13 (1)	●	●	●	●
Capacitor	6 (1)	●	●		●
Sensor	4	●	●	●	
Battery *Secondary batteries, fuel cells	12 (4)	●	●		●
Automotive parts	7 (2)	●	●		●
PC/Mobile	8 (5)	●			
Equipment Manufacturing	3	●		●	
Metal processing	1		●		
Material Manufacturing	1		●		

Activity	Embedded Software design, System design Software development environment design License & Module sales
Customer	Panasonic, others
Establishment	January 10th, 1997
Chairman	Cheng-Kung Lin
President	Shogo Nakazawa
Capital	200 million yen



As of Sep 1, 2025

Head office

Nagaokakyo/Kyoto

1 Kotari-yakemachi, Nagaokakyo City,
Kyoto 617-8520,



ISO-9001



JQA-QMA16899

ISO/IEC-27001



IC24J0576

Branch office

Shin-yokohama/Kanagawa

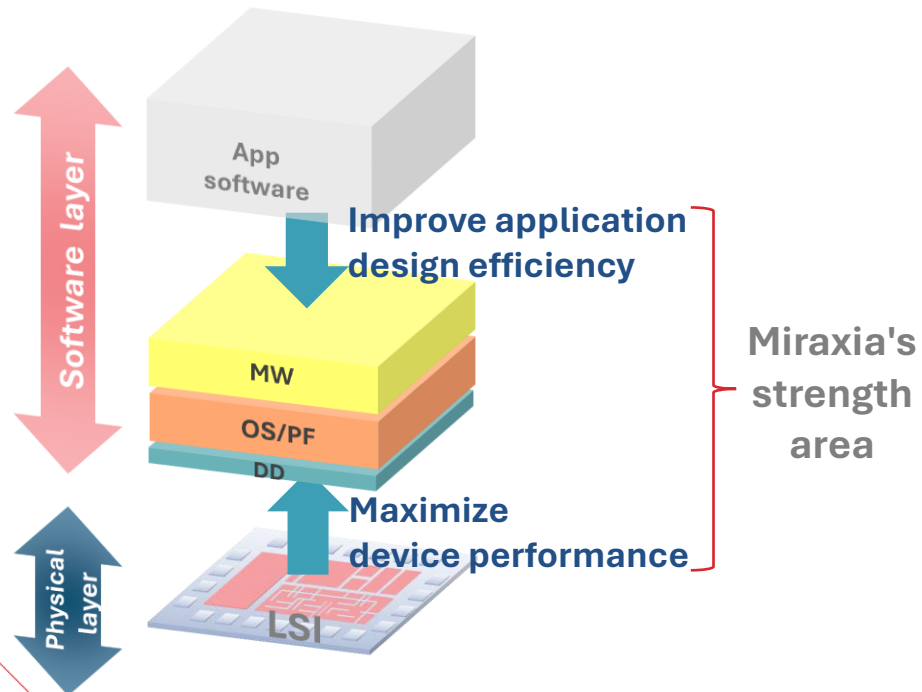
Shin-yokohama TECH building 1, 8, 10, 11
3-9-18 Shin-yokohama, Kohoku-Ku,
Yokohama city. 222-0033



- Device system integration skills to maximize device performance and streamline application software design

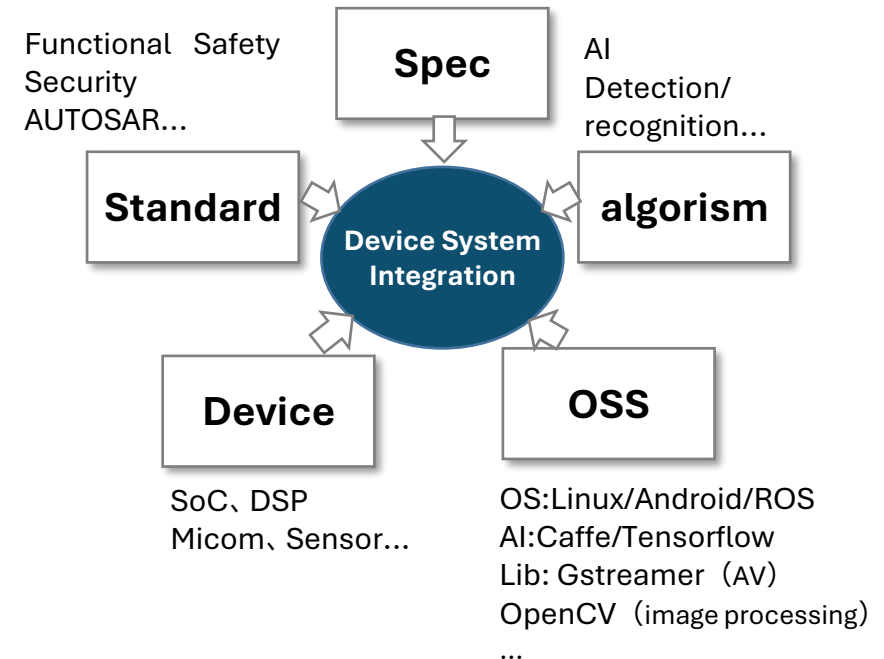
MIRAXIA's strength area

Miraxia has a lot of experience to develop embedded software. Especially software layer near hardware is METC's strength area.

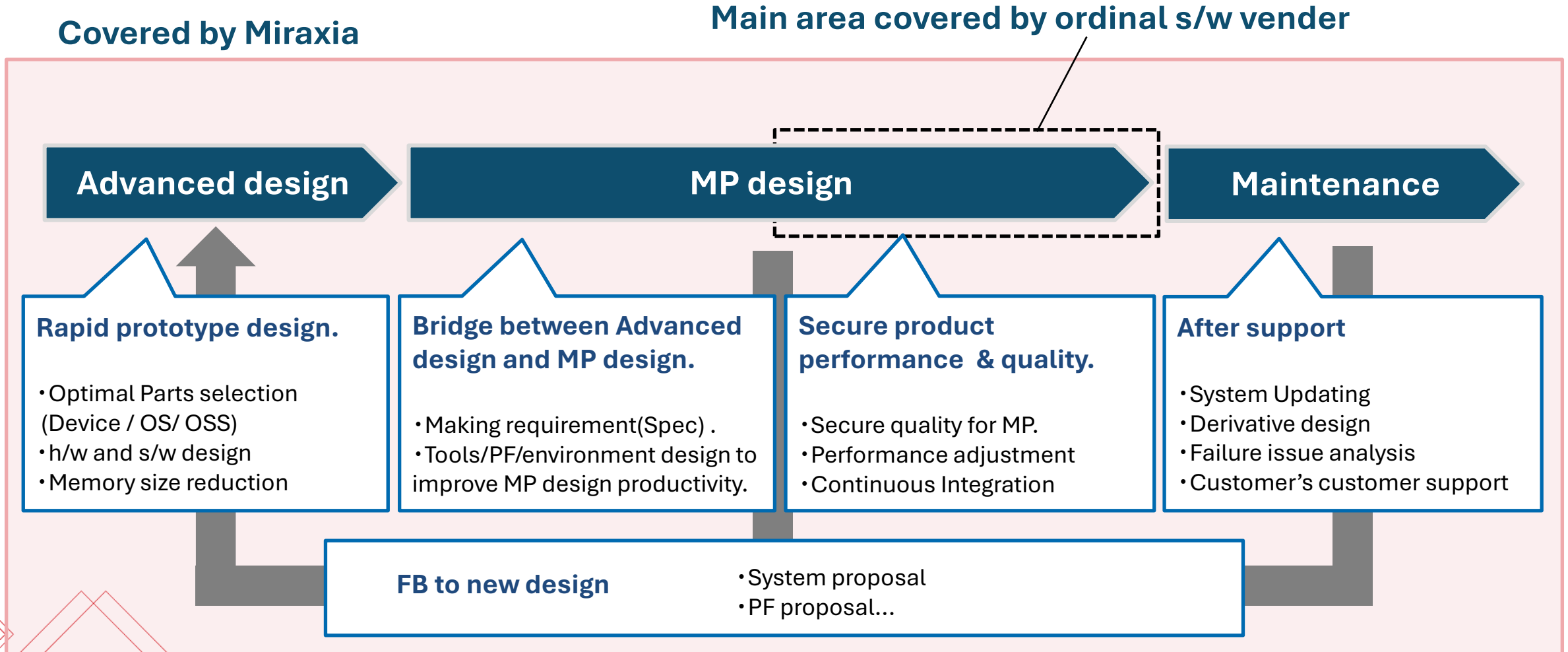


Core skill of MIRAXIA (Device system integration)

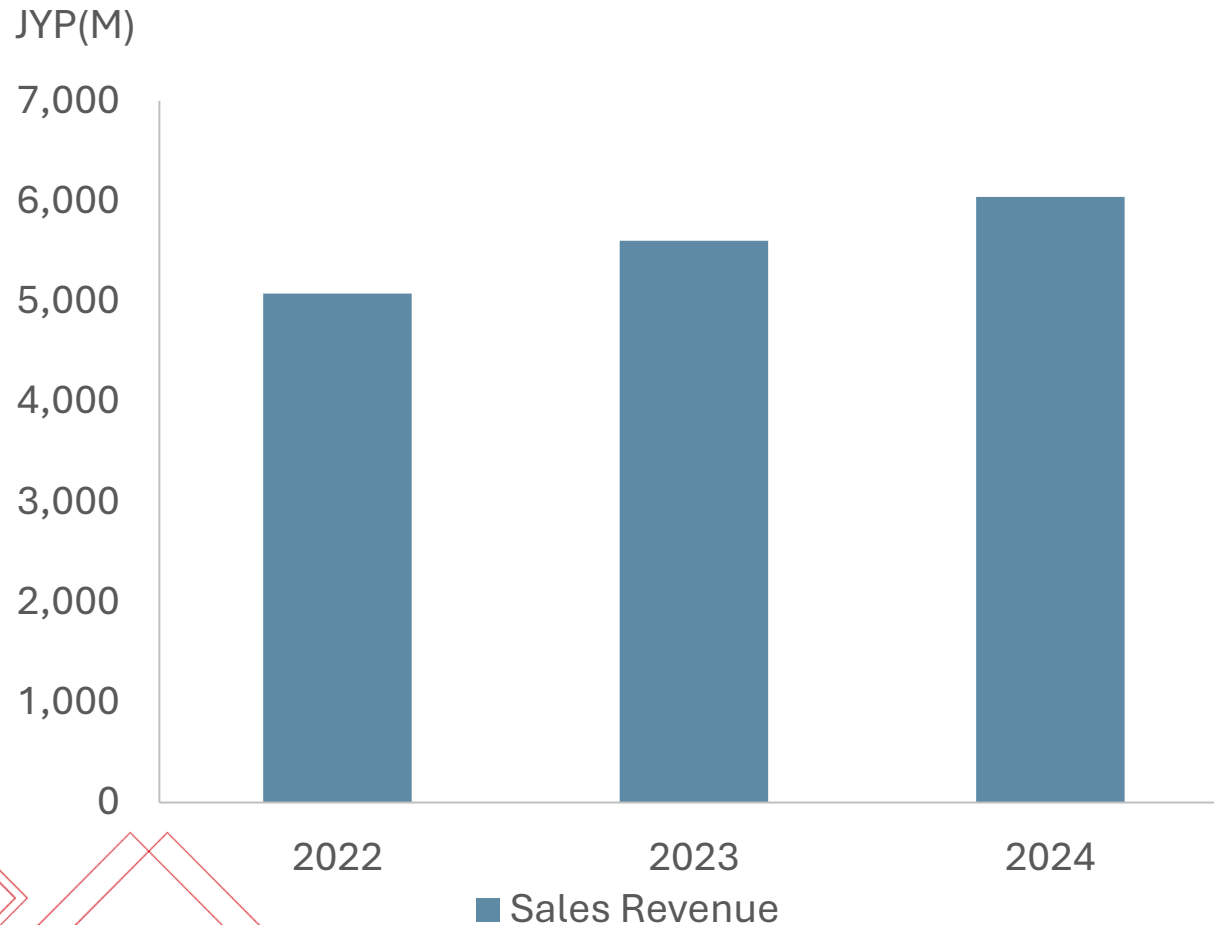
Based on wide range of knowledge, Miraxia can build an optimal device system with considering each requirement.



- Compare with ordinal software vendor, Miraxia has many experience to involve in not only design based on clearly defined requirement but also upstream design and maintenance too



- Grown to a wide range of embedded system design, taking advantage of our design skills and technology acquired through designing of semiconductors and embedded equipment
- Currently Automotive & Industrial fields are our focus sectors



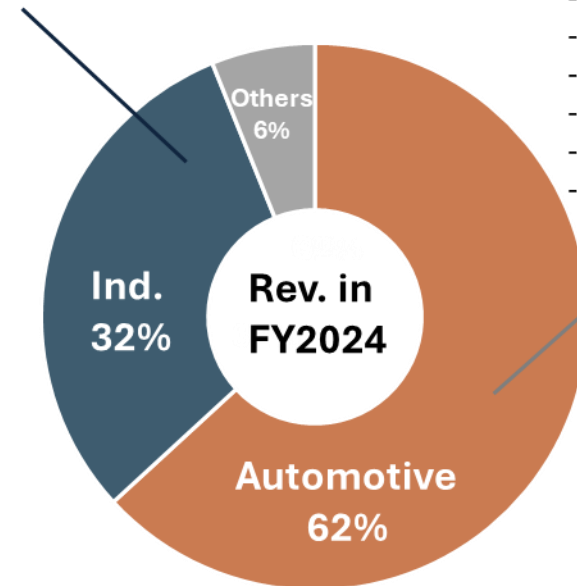
Sales by Core Business

e.g. Industrial related PJ

- Sensing solution
- Motion controller for factory automation
- Bi-direction power management

e.g. Automotive related PJ

- Vehicle camera module
- IVI(In-vehicle Infotainment) system
- ADAS-ECU
- Cockpit ECU
- Gateway ECU
- Battery Charger unit



* Others including AV, Home appliance, Medical, semiconductor, ...

- Miraxia has many s/w design experience in Vehicle market

Cockpit/Connecting

- Gateway ECU
- Cockpit ECU
- IVI(In-Vehicle Informant)

Safety/Autonomous driving

- ADAS ECU
- Camera module
- Smart mirror
- Driver monitoring

Power train/ Body control

- Engine ECU
- Inverter
- Battery management

Rear camera with human detection



IVI

Around view camera



Side mirror camera



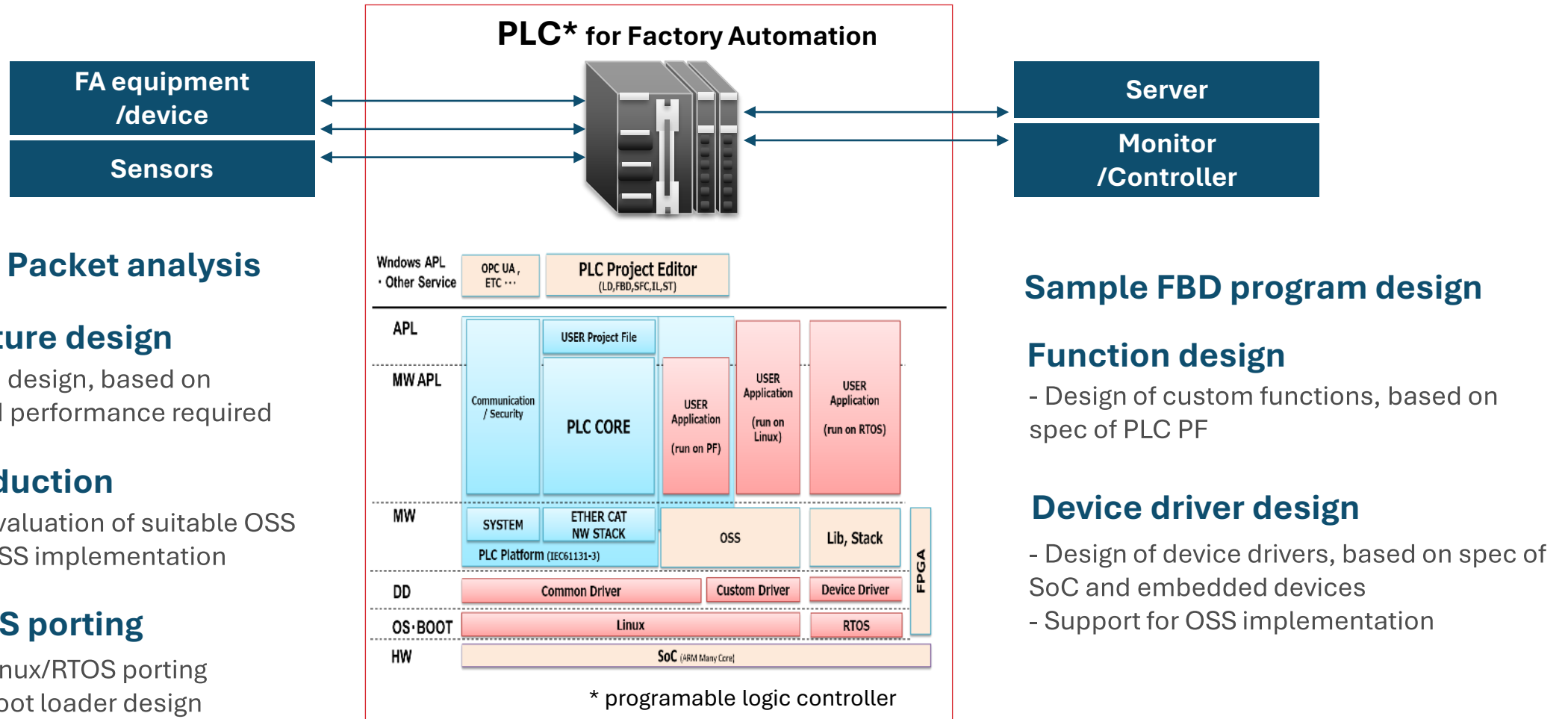
Driver monitoring

Vehicle battery charger



eAxle

- Miraxia has extensive experience in PLC development, contributing to development of smart PLC



Packet analysis

Architecture design

- Architecture design, based on functions and performance required

OSS introduction

- Selection & evaluation of suitable OSS
- Support for OSS implementation

OS porting

- Linux/RTOS porting
- Boot loader design

Sample FBD program design

Function design

- Design of custom functions, based on spec of PLC PF

Device driver design

- Design of device drivers, based on spec of SoC and embedded devices
- Support for OSS implementation

Issue analysis and countermeasure planning

- Miraxia provides power electronics design solutions with s/w, h/w design references and engineering service

METC provides

- Reference design
with hardware & software

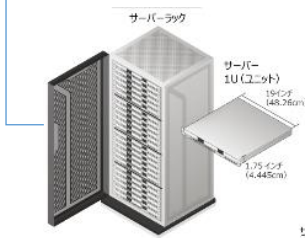


Bi-direction ACDC/DCDC reference board
(Isolated/non-Isolated) with sample s/w

- Engineering service



Design Record

Company A	Company B	Company C
Server UPS (3kW)	V2H (6kW)	V2X (10kW)
Software + Hardware	Software + Hardware	Software
  サーバーラック サーバー 1U (ユニット) 19インチ (48.26cm) 1.75-インチ (4.45cm)	 	

Q & A



Thank you